MA3X721 (MA721)

Silicon epitaxial planar type

For super high speed switching For small current rectification

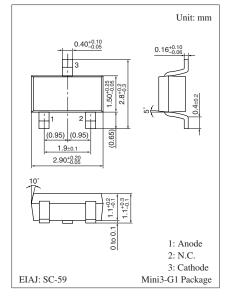
Features

• Forward current (Average) $I_{F(AV)} = 200$ mA rectification is possible

3 "						
Parameter	Symbol	Rating	Unit			
Reverse voltage	V _R	30	V			
Maximum peak reverse voltage	V _{RM}	30	V			
Forward current	I_F	200	mA			
Peak forward current	I _{FM}	300	mA			
Non-repetitive peak forward surge current *	I _{FSM}	1	А			
Junction temperature	Tj	150	°C			
Storage temperature	T _{stg}	-55 to +150	°C			

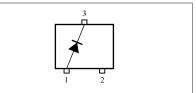
Absolute Maximum Ratings $T_a = 25^{\circ}C$

Note) *: The peak-to-peak value in one cycle of 50 Hz sine wave (non-repetitive)



Marking Symbol: M1M

Internal Connection



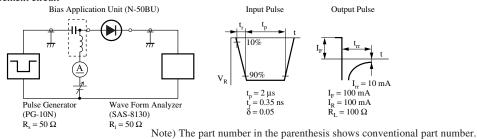
Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	V _F	$I_F = 200 \text{ mA}$			0.55	V
Reverse current	I _R	$V_R = 30 V$			50	μΑ
Terminal capacitance	Ct	$V_R = 0 V, f = 1 MHz$		30		pF
Reverse recovery time *	t _{rr}	$I_F = I_R = 100 \text{ mA}$		3.0		ns
		$I_{rr} = 10 \text{ mA}, R_L = 100 \Omega$				

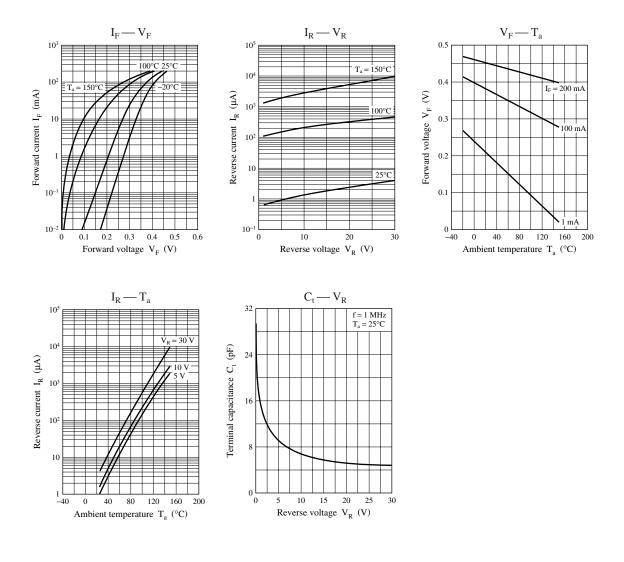
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.

- 3. Absolute frequency of input and output is 1 GHz.
- 4. *: trr measurement circuit



Panasonic



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